

10G 20km LC BIDI SFP+ Transceiver

NNX-2396Bi-20D / NNX-3296Bi-20D

Overview:

This 10GBASE-BR 20km transceiver is hot pluggable 3.3V Small-Form-Factor transceiver module. It designed expressly for high-speed communication applications that require rates up to 11.3Gb/s, it designed to be compliant with SFF-8472 SFP+ MSA. The module data link up to 20km in 9/125um single mode fiber.



Features:

- Up to 11.3 Gbps data rate
- 1270nm DFB Tx/1330nm PIN Rx for SFP-10G-BXU-20
- 1330nm DFB Tx/1270nm PIN Rx for SFP-10G-BXD-20
- Simplex LC receptacle optical interface compliant
- Single +3.3V power supply
- Hot-pluggable
- AC coupling of LVPECL signals
- International Class1 laser safety certified
- Operating temperature range:
 - Commercial: -5°C~70°C
 - Industrial: -40°C~85°C
- RoHS Compliant
- DDMI function available with internally calibrated mode

Application

- 10GBASE-ER/LW
- 10G Fiber Channel
- 10G SONET/SDH, OTU2/2e
- 10GBASE-BX

Standard

- Compliant with MSA SFP+ specification(SFF-8431)
- Compliant with SFF-8472
- CPRI Line Rate Option: 9830.4Mbps,
- Compliant to IEEE 802.3ae

Specification:

Absolute Maximum Ratings				
Parameter	Symbol	Min	Max	Unit
Storage temperature	TS	-40	85	°C
Power Supply Voltage	Vcc	-0.5	+4	V
Relative Humidity	RH	5	95	%

Recommended Operating Conditions					
Parameter	Symbol	Min	Typical	Max	Unit
Operating Case Temperature (Commercial)	Tc	-5		70	°C
Operating Case Temperature (Industrial)		-40		85	
Power Supply Voltage	Vcc	3.13	3.3	3.47	V
Supply Current	Icc			300	mA
Data Rate			10.3125		Gbps
Fiber Length 9/125μm core SMF		-	-	20	km

Electrical Characteristics						
Parameter	Symbol	Min	Typical	Max	Unit	Notes
Transmitter differential input voltage		180		850	mV	
Receiver differential output Voltage		300		850	mV	
Transmit Fault (TX_Fault)	Voh	2.4		Vcc+0.3	V	LVTTL
	Vol	-0.3		0.4	V	LVTTL
Loss of Signal (LOS)	Voh	2.4		Vcc+0.3	V	LVTTL
	Vol	-0.3		0.4	V	LVTTL
TX Disable	Vih	2		Vcc+0.3	V	LVTTL
	Vil	-0.3		0.8	V	LVTTL

Optical transmitter Characteristics						
Parameter	Symbol	Min	Typical	Max	Unit	Notes
Launched Power (avg.)	Pout	0		5	dBm	
Operating Wavelength Range	λ_c	1320	1330	1340	nm	
		1260	1270	1280		
Spectral Width	$\Delta\lambda$			1	nm	DFB

Side Mode Suppression Ratio		SMSR	30			dB	
Extinction Ratio		ER	3.5			dB	2
Relative Intensity Noise		RIN			-128	dB/Hz	
Optical Return Loss			12			dB	
Transmitter and Dispersion Penalty		TDP			3.2	dB	
Optical Tx Output disable		Pdis			-45	dBm	
Output Eye Diagram		Complies with IEEE802.3ae eye masks when filtered					
Optical receiver Characteristics							
Parameter		Symbol	Min	Typical	Max	Unit	Notes
Receiver Sensitivity		P _{SEN}			-15	dBm	4
Wavelength Range		λ _C	1320		1340	nm	
			1260		1280		
Input Saturation Power (Overload)		P _{SAT}	0.5			dBm	4
Receiver Reflectance					-12	dB	
LOS	Optical De-assert	LOSD			-17	dBm	4
	Optical Assert	LOSA	-30				
LOS hysteresis			0.5		5	dB	5

Note1. The supply current is SFP+ module's working current.

Note2. For the measurements, the device was driven with 2³¹-1 PRBS pattern

Note3. Optical transition time is the time interval required for the rising or falling edge of an optical pulse to transition between the 20% and 80% amplitudes relative to the logical 1 and 0 levels.

Note4. Measured with a PRBS 2³¹-1 test pattern, @10.3125Gbps, ER=4dB, BER<10⁻¹²

Note5. The LOS Hysteresis minimizes 'chatter' on the output line. In principle, Hysteresis alone does not guarantee chatter-free operation.

Digital Diagnostic Monitoring Information

Parameter	Accuracy	Calibration	Note
Temperature	±3°C	internal	-40~85
Voltage	±3%	internal	V _{CC} =3.3V±5%
Bias Current	±10%	internal	Specified by normal value
TX Power	±2dB	internal	0~5dBm
RX Power	±3dB	internal	-15~+0.5dBm

Pin Definition

The SFP+ modules are hot-pluggable. Hot pluggable refers to plugging in or unplugging a module while the host board is powered. The SFP+ host connector is a 0.8 mm pitch 20 position right angle improved connector specified by SFF-8431, or stacked connector with equivalent with equivalent electrical performance. Host PCB contact assignment is shown in Figure 1 and contact definitions are given in Table 5. SFP+ module contacts mates with the host in the order of ground, power, followed by signal as illustrated by Figure 2 and the contact sequence order listed in the table.

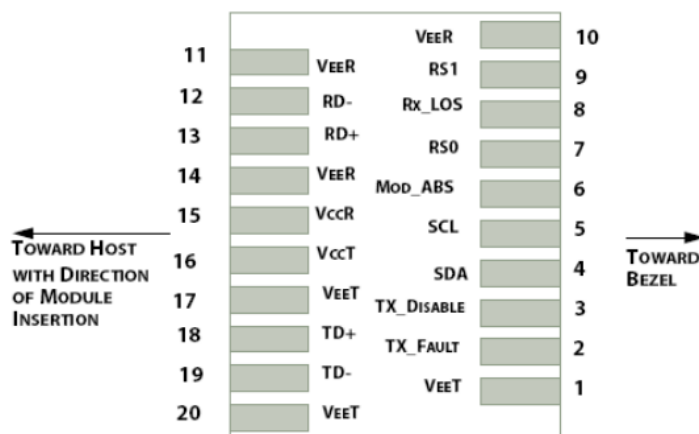


Figure 1. SFP+ Pad assignment Top View

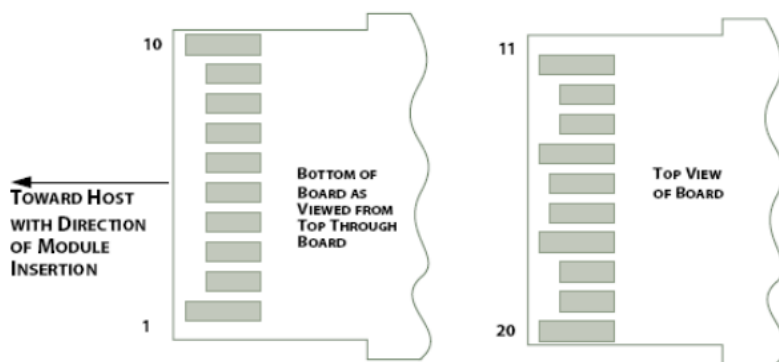


Figure 2. SFP+ Module Contact Assignments

Pin	Symbol	Name/Description	Power Seq.	Ref.
1	VeeT	Transmitter Ground (Common with Receiver Ground)	1st	1
2	TX_Fault	Transmitter Fault, Low: normal; High: abnormal	3rd	2
3	TX_Disable	Transmitter Disable High: Transmitter off Low: Transmitter on	3rd	3
4	SDA	2-Wire Serial Interface Data Line	3rd	4

		(Same as MOD-DEF2 in INF-8074i)		
5	SCL	2-Wire Serial Interface Data Line (Same as MOD-DEF2 in INF-8074i)	3rd	4
6	Mod_ABS	Module Absent, Connect to VeeT or VeeR in Module	3rd	5
7	RS0	Rate Select 0, optionally controls SFP+ module receiver	3rd	6
8	RX_LOS	Receiver Loss of Signal indication High: loss of signal Low: signal detected	3rd	7
9	RS1	Rate Select 1, optionally controls SFP+ module transmitter	3rd	8
10	VeeR	Receiver Ground	1st	1
11	VeeR	Receiver Ground	1st	1
12	RD-	Receiver Inverted DATA out. AC Coupled. CML-O	3rd	9
13	RD+	Receiver Non-inverted DATA out. AC Coupled. CML-O	3rd	9
14	VeeR	Receiver Ground	1st	1
15	VccR	Receiver Power Supply	2nd	10
16	VccT	Transmitter Power Supply	2nd	10
17	VeeT	Transmitter Ground	1st	1
18	TD+	Transmitter Non-Inverted DATA in. AC Coupled. CML-I	3rd	11
19	TD-	Transmitter Inverted DATA in. AC Coupled. CML-I	3rd	11
20	VeeT	Transmitter Ground	1st	1

SFP+ Module PIN Definition

Power Seq.: Pin engagement sequence during hot plugging.

Note1. The module signal ground contacts.

Note2. This pin is an open drain/collector and should be pulled up to Vcc-host in the host with a 4.7k~10k Ohm resistor.

Note3. This pin should be pulled up to Vcct with a 4.7k~10k Ohm resistor in modules.

Note4. SDA&SCL (IIC) are needed pull up 4.7k~10k Ohm resistors on host board.

Note5. Mod_ABS is connected to VeeT or VeeR in the SFP+ module.

Note6. Rate Select 0,Optionally controls SFP+ module receiver , High: RX input signaling rate>4.25GBd and Low: RX input signaling rate≤4.25GBd.

Note7. Module RX_Los of signal indication need pull up 4.7k~10k Ohm resistor on host board.

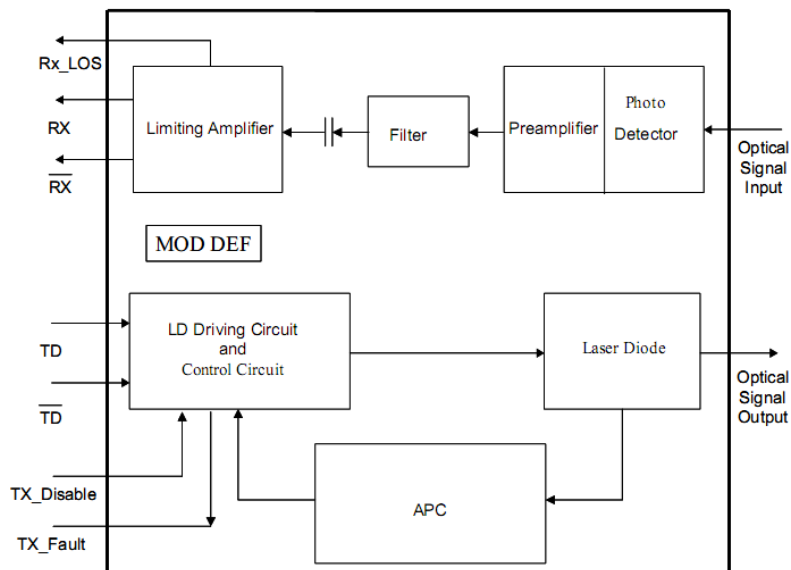
Note8. Rate Select 1,Optionally controls SFP+ module transmitter, High: Tx input signaling rate>4.25GBd and Low : Tx input signaling rate≤4.25GBd.

Note9. RD -/+ : These are the differential receiver outputs. They are CML AC-coupled with 100 Ohm terminal resistor matching internal.

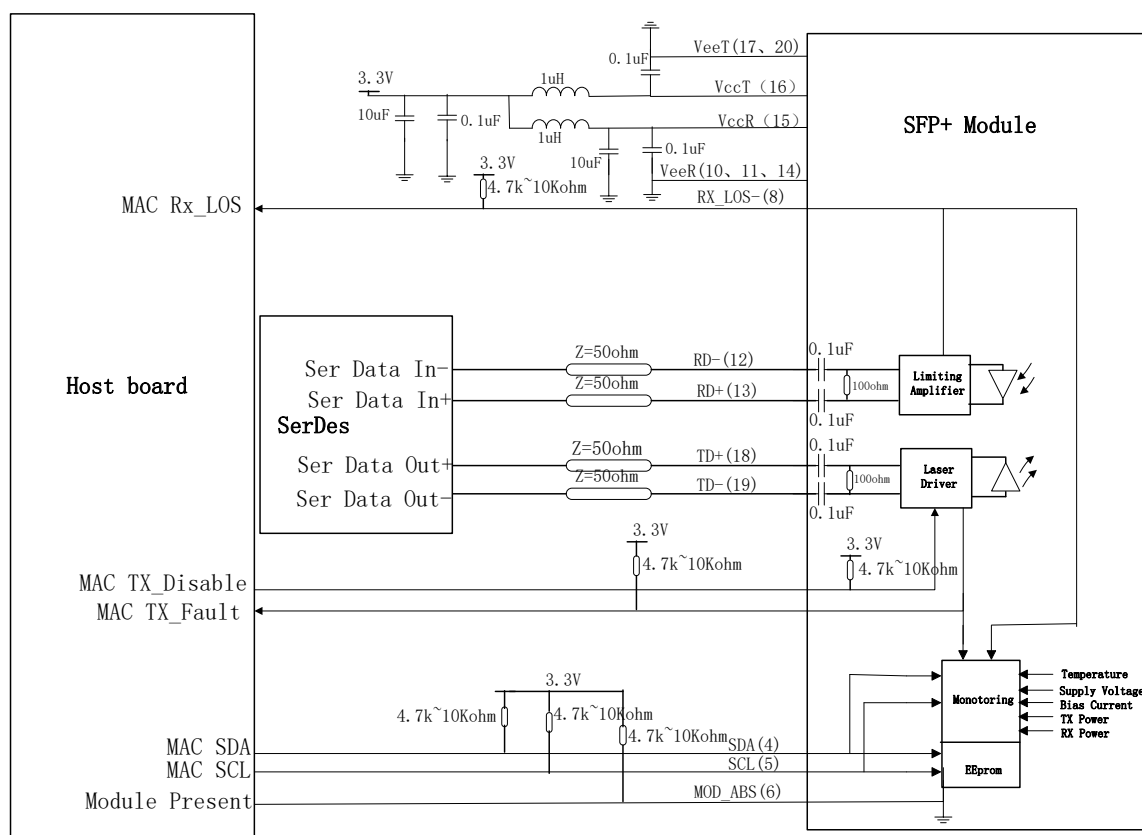
Note10. VccR and VccT are the receiver and transmitter power supplies.

Note11. TD-/+ : These are the differential transmitter inputs. They are CML AC-coupled with 100 Ohm terminal resistor matching internal.

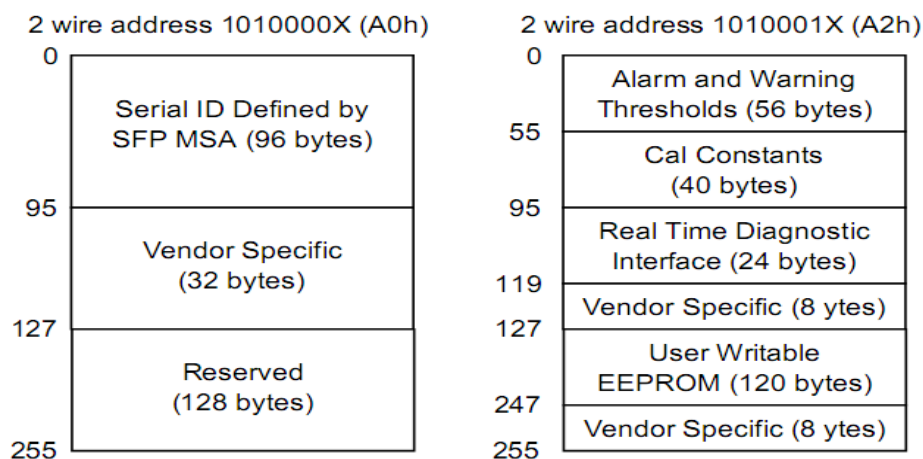
Block Diagram



Typical application Circuit



Digital Diagnostic Memory Map



EEPROM Serial ID Memory Contents

The optical transceiver contains an EEPROM. It provides access to sophisticated identification information that describes the transceiver's capabilities, standard interfaces, manufacturer, and other information. When the serial protocol is activated, the host generates the serial clock signal (SCL, Mod Def 1). The positive edge clocks data into those segments of the EEPROM that are not writing protected within the SFP transceiver. The negative edge clocks data from the SFP transceiver. The serial data signal (SDA, Mod Def 2) is bi-directional for serial data transfer. The host uses SDA in conjunction with SCL to mark the start and end of serial protocol activation. The memories are organized as a series of 8-bit data words that can be addressed individually or sequentially.

The Module provides diagnostic information about the present operating conditions. The transceiver generates this diagnostic data by digitization of internal analog signals. Calibration and alarm/warning threshold data is written during device manufacture. Received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring all are implemented. The diagnostic data are raw A/D values and must be converted to real world units using calibration constants stored in EEPROM locations 56 – 95 at wire serial bus address A2h. The digital diagnostic memory map specific data fields define as following.

EEPROM Serial ID Memory Contents (2-Wire Address A0h)

Address	Name of field	Hex	Description
BASE ID Fields			
00	Identifier	03	SFP transceiver
01	Ext. Identifier	04	Serial ID module supported for SFP
02	Connector	07	LC
03-10	Transceiver Codes		
11	Encoding	06	Encoding codes
12	BR, Nominal	67	10.3Gbps
13	Rate Identifier	00	Not defined
14	Length(9um)-km	28	20KM
15	Length(9um)-100m	FF	20000M
16	Length(50um)	00	Transceiver transmit distance
17	Length(62.5um)	00	
18	Length(cable)	00	Not support cable
19	Length(OM3)	00	Not support OM3
20-35	Vendor Name	xx xx ... xx xx	
36	Reserved	00	Not defined
37-39	Vendor OUI	00 00 00	Not defined
40-55	Vendor P/N	xx xx ... xx xx	
56-59	Vendor P/N Rev.	41 30 20 20	"A0"(ASCII character)
60-61	Laser Wavelength	04 F6/05 32	1270/1330nm
62	Reserved	00	Not defined
63	CC_BASE	xx	Check sum of bytes 0-62
Extended ID Fields			
64-65	Options	00 1A	RX_LOS、TX_Faultare implemented
66	BR, max	00	Upper bit rate margin,0%
67	BR, min	00	Lower bit rate margin,0%
68-83	Vendor SN		Vendor Serial Number in ASCII character
84-91	Date Code	Data Code	Vendor Date Code in ASCII character
92	Diagnostic Monitoring Type	68	Digital Diagnostic monitoring implemented "Internally calibrated " is implemented, RX measurement type is "Average Power"
93	Enhanced options	B0	Optional Alarm/warning flags, soft Tx_Fault monitoring, soft LOS monitoring are implemented

Package Outline

Technical drawing of the 1000 Series RJ45 connector showing front, side, and isometric views with dimensions in millimeters.

Dimensions (mm):

- Front View:
 - Overall Width: 11.64 ± 0.05
 - Overall Height: 24.00 ± 0.05
 - Mounting Tab Width: 13.90 ± 0.1
 - Mounting Tab Height: 13.70 ± 0.1
 - Internal Width: 9.20
 - Internal Height: 2.20 ± 0.08
 - Internal Width (Top): 2.50 ± 0.08
 - Internal Height (Top): 0.50 ± 0.08
 - Internal Width (Bottom): 41.80 ± 0.1
 - Internal Height (Bottom): 45.00 ± 0.1
- Side View:
 - Overall Height: 56.70
 - Mounting Tab Width: 13.90 ± 0.1
 - Mounting Tab Height: 13.70 ± 0.1
 - Internal Width: 9.20
 - Internal Height: 2.20 ± 0.08
 - Internal Width (Top): 2.50 ± 0.08
 - Internal Height (Top): 0.50 ± 0.08
 - Internal Width (Bottom): 41.80 ± 0.1
 - Internal Height (Bottom): 45.00 ± 0.1
- Isometric View:
 - Overall Width: 11.64 ± 0.05
 - Overall Height: 24.00 ± 0.05
 - Mounting Tab Width: 13.90 ± 0.1
 - Mounting Tab Height: 13.70 ± 0.1
 - Internal Width: 9.20
 - Internal Height: 2.20 ± 0.08
 - Internal Width (Top): 2.50 ± 0.08
 - Internal Height (Top): 0.50 ± 0.08
 - Internal Width (Bottom): 41.80 ± 0.1
 - Internal Height (Bottom): 45.00 ± 0.1

Tolerance Level Table:

TOLERANCE LEVEL	
X.	± 0.20
.X	± 0.15
.XX	± 0.10
.XXX	± 0.05

Regulatory Compliance

Feature	Test	Method
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883E Method 3015.7	Class 1(>1000V for SFI pins, >2000Vfor other pins.)
Electrostatic Discharge (ESD) Immunity	IEC61000-4-2	Class 2(>4.0kV)
Electromagnetic Interference (EMI)	CISPR22 ITE Class B FCC Class B CENELEC EN55022 VCCI Class 1	Comply with standard
Immunity	IEC61000-4-3	Comply with standard
Eye Safety	FDA 21CFR 1040.10 and 1040.11 EN (IEC) 60825-1,2	Compatible with Class I laser Product